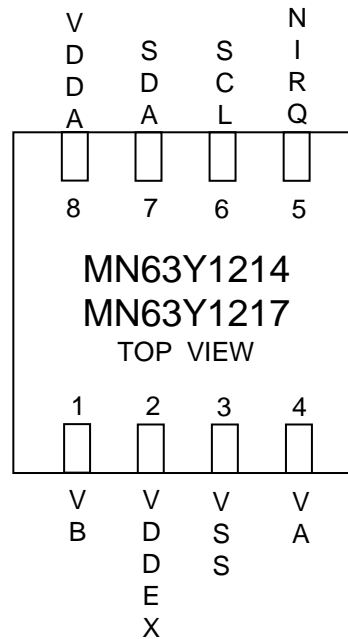


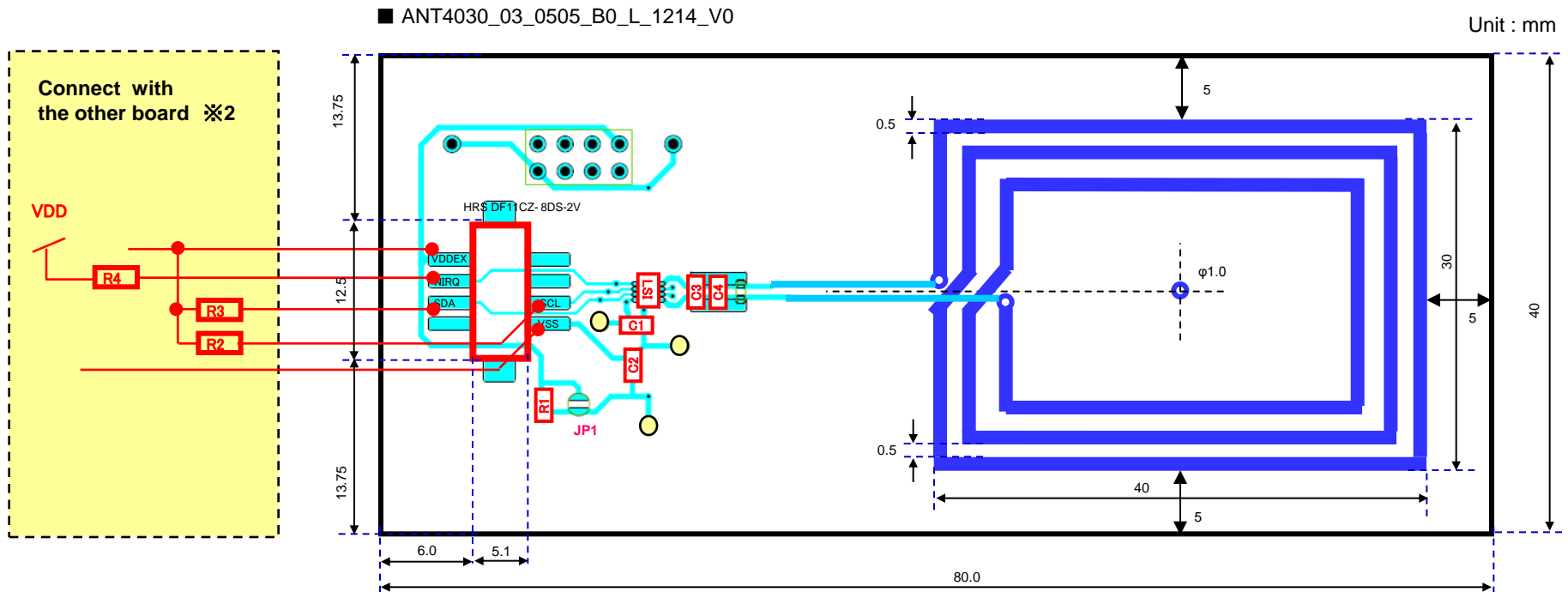
**Evaluation board circuit diagram  
and implementation  
MN63Y1214/1217**

Ver. 1.1  
Aug. 19, 2014

Sensing Systems Development Center  
Semiconductor Business Unit  
Panasonic Semiconductor Solutions Co.,Ltd.



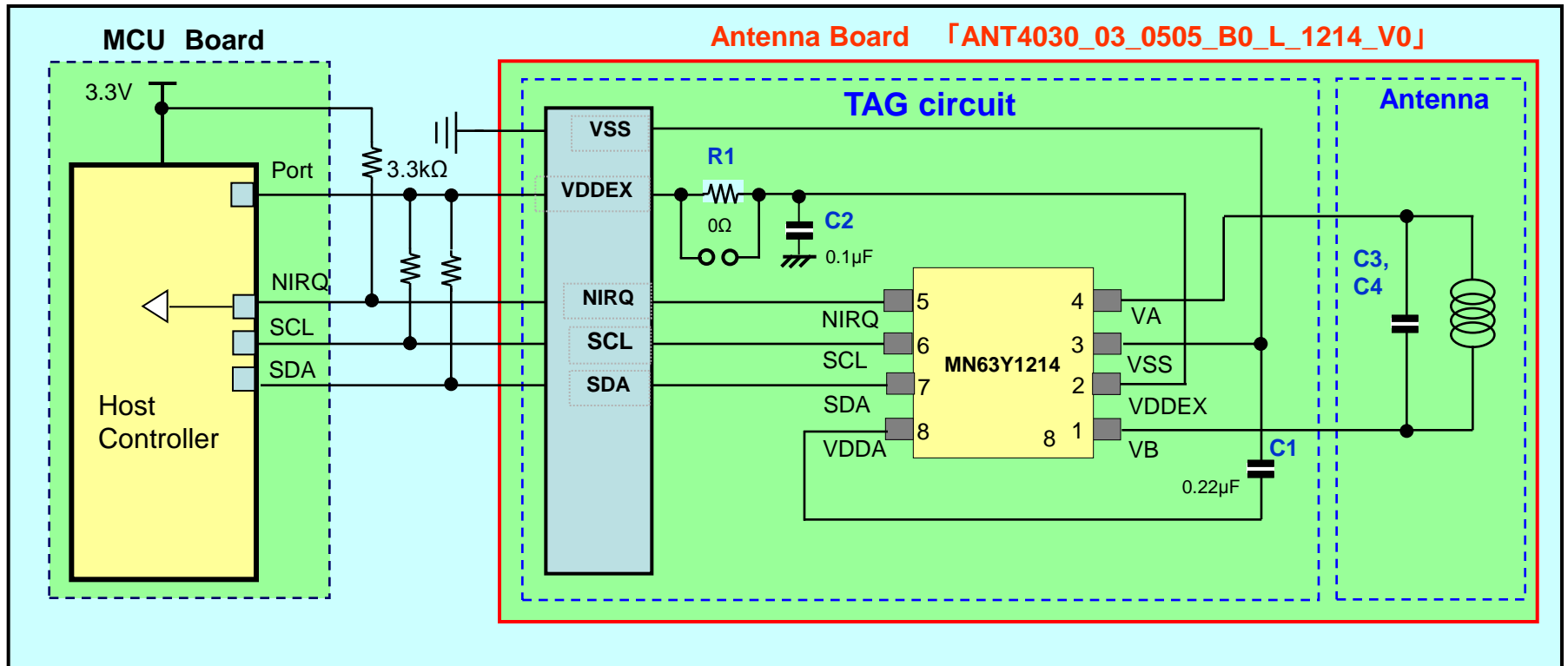
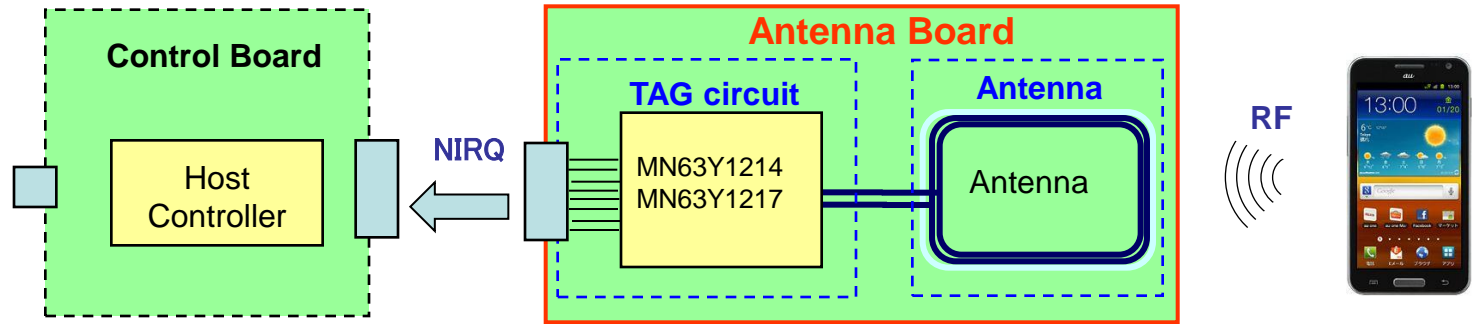
| Pin No. | Name  | Input/Output | IO type    | function   |
|---------|-------|--------------|------------|--|
| 1       | VB    | I/O          | ---        | Coil terminal  |
| 2       | VDDEX | ---          | Power      | External Power Supply  |
| 3       | VSS   | ---          | GND        | Ground   |
| 4       | VA    | I/O          | ---        | Coil terminal  |
| 5       | NIRQ  | Output       | Open Drain | USE : Pull up to VDDEX<br>NOT USE : Open or Connect to Ground  |
| 6       | SCL   | Input        | ---        | I2C Clock input  |
| 7       | SDA   | I/O          | Open Drain | I2C Data input/output. Pull up to VDDEX  |
| 8       | VDDA  | ---          | Power      | Internal analog power supply<br>(Connect a capacitor between this pin and VSS shortest as possible.) |



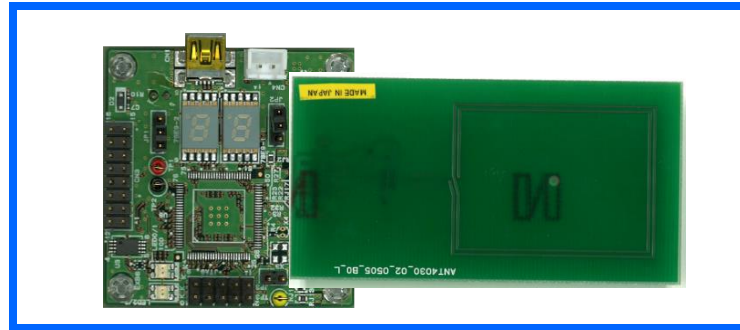
- ※ Substrate size may differ from the substrate which exists to a visitor.  
 ※ I connect pulling up resistance (R2,R3,R4) to the microcomputer board of our offer.

| External parts | Recommended Value | Detail explanation  |
|----------------|-------------------|---|
| R2,R3          | 3.3kΩ             | These are pull up resistor for I2C signal lines. Please choose the value considering data speed, parasitic capacitance of signal lines, and current drive performance.<br>In our NFC tag board " ANT4030_03_0505_B0_L_1214_V0 " it is not implemented.        |
| R4             | 3.3kΩ             | This is pull up resistor for interrupt signal lines.<br>Please choose the value considering data speed, parasitic capacitance of signal lines, and current drive performance.<br>In our NFC tag board " ANT4030_03_0505_B0_L_1214_V0 " it is not implemented. |
| C1<br>C2       | 0.22μF<br>0.1μF   | It is a fixed value at the capacity between the power supply for operation stabilization of the tag LSI.<br>C1 is connected to VDDA, and C2 is connected to VDDEX.  |
| C3, C4         | -                 | It is Resonance capacity. The optimal values differ for every antenna design. It is connected VA to VB.<br>In our NFC tag board " ANT4030_03_0505_B0_L_1214_V0 ", capacity C3=150pF, the C4=22pF has been implemented.  |
| R1             | -                 | In our NFC tag board " ANT4030_03_0505_B0_L_1214_V0 ", the resistance of R1=0Ω has been implemented.  |

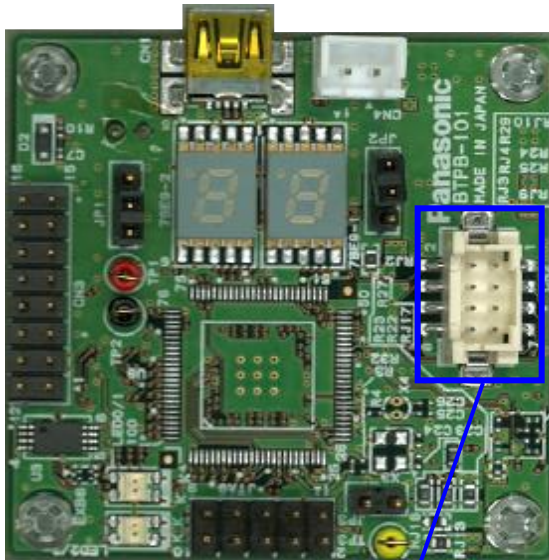
## NFC tag system constitution



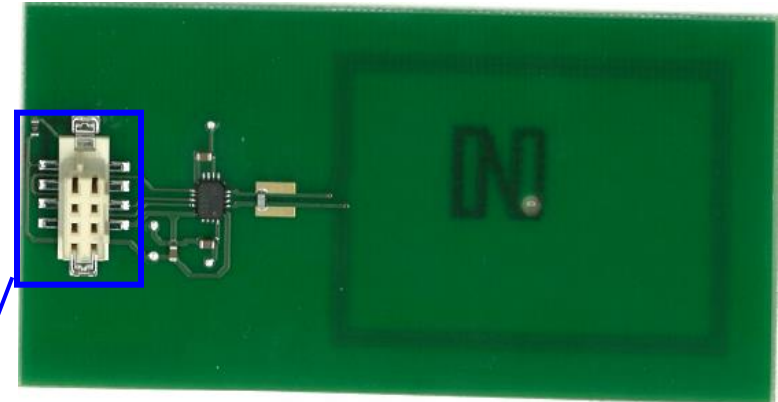
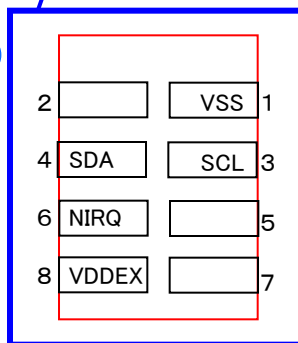
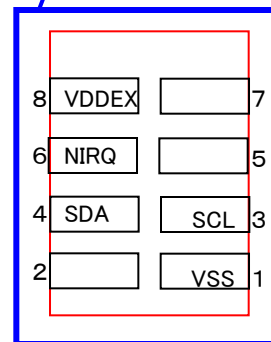
## Connection image (Top view)



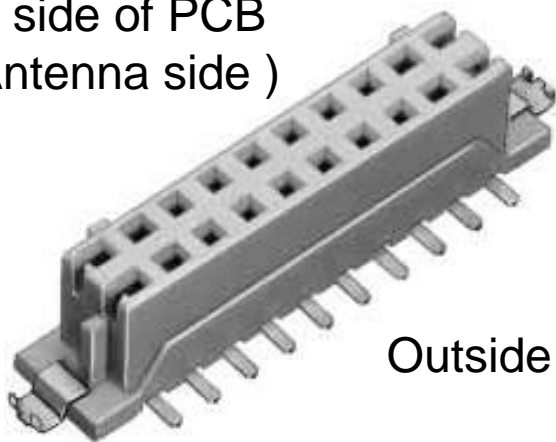
Micon board [BTPB-101B]



Antenna board [ANT4030\_03\_0505\_B0\_L\_1214\_V0]

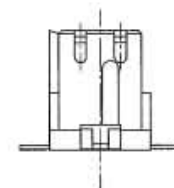
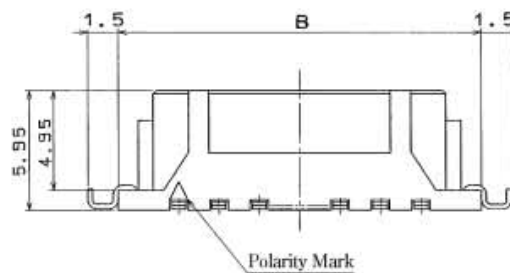
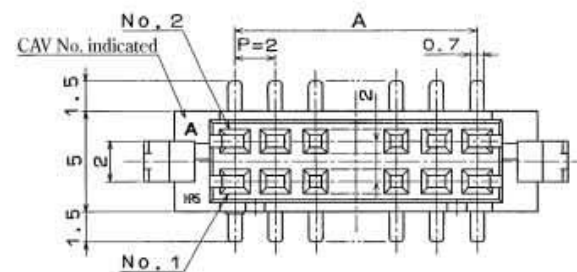
DF11CZ-8DP-2V(27)  
( Hirose Electric )HRS DF11CZ- 8DS-2V  
( Hirose Electric )

In side of PCB  
( Antenna side )



Outside of PCB

※Figure is an example



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